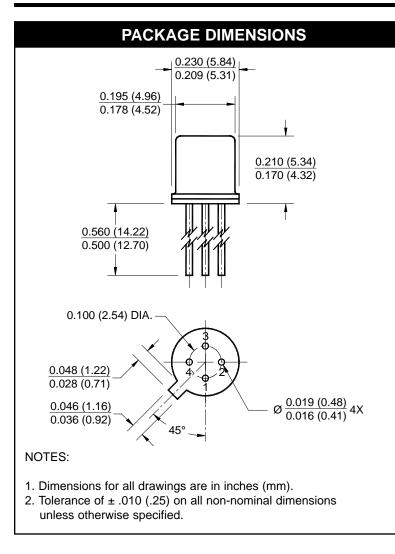
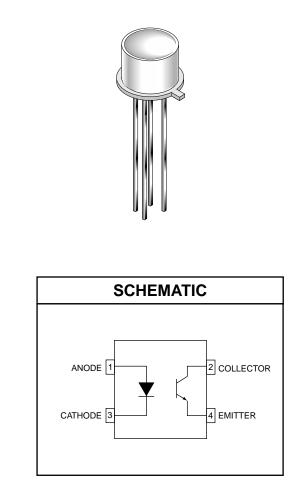


# MCT4





### DESCRIPTION

The MCT4 is a standard four-lead, TO-18 package containing a GaAs infrared emitting diode optically coupled to an NPN silicon planar phototransistor.

### FEATURES

- Hermetically package
- High current transfer ratio; typically 35%
- High isolation resistance; 10<sup>11</sup> ohms at 500 volts
- High voltage isolation emitter to detector



# MCT4

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise specified)						
Parameter	Symbol	Rating	Unit			
Operating Temperature	Topr	-55 to +125	0°			
Storage Temperature	T <sub>STG</sub>	-65 to +150	°C			
Soldering Temperature (Flow)	T <sub>SOL-F</sub>	260 for 10 sec	0°C			
EMITTER	P					
Power Dissipation at 25°C Ambient <sup>(1)</sup>	P <sub>D</sub>	90	mW			
Continuous Forward Current	١ <sub>F</sub>	40	mA			
Reverse Voltage	V <sub>R</sub>	3	V			
Forward Current - Peak (1 µs pulse, 300 pps)	l <sub>F</sub> (pk)	3.0	A			
DETECTOR	<b>_</b>					
Power Dissipation 25°C Ambient <sup>(2)</sup>	P <sub>D</sub>	200	mW			
Collector to Emitter Voltage	V <sub>CEO</sub>	30	V			
Emitter to Collector Voltage	V <sub>ECO</sub>	7	V			
COUPLER						
Total Power Dissipation <sup>(3)</sup>	P <sub>D</sub>	250	mW			
Isolation Voltage		1000	VDC			

ELECTRICAL / OPTICAL CHARACTERISTICS (T <sub>A</sub> =25°C)							
INDIVIDUAL COMPONENT CHARACTERISTICS							
Parameters	Test Conditions	Symbol	Min	Тур	Max	Units	
EMITTER							
Forward Voltage	I <sub>F</sub> = 40 mA	V <sub>F</sub>		1.30	1.50	V	
Reverse Current	V <sub>R</sub> = 3.0 V	I <sub>R</sub>		0.15	10	μA	
Capacitance	V = 0 V	С		150		pF	
DETECTOR							
Breakdown Voltage							
Collector to Emitter	l <sub>C</sub> = 1.0 mA, l <sub>F</sub> = 0	BV <sub>CEO</sub>	30			V	
Emitter to Collector	$I_{E} = 100 \ \mu A, \ I_{F} = 0$	BV <sub>ECO</sub>	7	12		V	
Leakage Current				_			
Collector to Emitter	$V_{CE} = 10 \text{ V}, \text{ I}_{F} = 0$	I <sub>CEO</sub>		5	50	nA	
Capacitance	V <sub>CE</sub> = 0						
Collector to Emitter		C <sub>CE</sub>		2		pF	

#### NOTE:

1. Derate power linearly 1.2 mW/°C above 25°C

2. Derate power linearly 2.67 mW/°C above 25°C

3. Derate power linearly 3.3 mW/°C above 25°C



# MCT4

DC Characteristics	Test Conditions	Symbol	Min	Тур	Max	Units
COUPLED	101/1 10	CTR	45	35		%
DC current Transfer Ratio (note 1)	V <sub>CE</sub> = 10 V, I <sub>F</sub> = 10 mA		15			
Saturation Voltage	$I_{\rm C} = 500 \ \mu \text{A}, \ I_{\rm F} = 10 \ \text{mA}$	V <sub>CE(SAT)</sub>		0.1		V
	$I_{\rm C} = 2  \rm{mA},  I_{\rm F} = 50  \rm{mA}$			0.2	0.5	
AC Characteristics	Test Conditions	Symbol	Min	Тур	Max	Units
Capacitance LED to Detector				1.8		pF
Bandwidth (Fig. 5)	Note 2			300		kHz
Rise Time and Fall Time (see operating schematic	$I_{\rm C} = 2 \text{ mA}, V_{\rm CE} = 10 \text{ V}, \text{ Note } 3$			2		μs

ISOLATION CHARACTERISTICS							
Characteristic	Test Conditions	Symbol	Min	Тур	Max	Units	
Isolation Resistance	V = 500 VDC	R <sub>ISO</sub>	10 <sup>11</sup>	10 <sup>12</sup>		Ω	
Breakdown Voltage	Time = 1 sec		1000	1500		VDC	

#### NOTE:

1. The current transfer ratio  $(I_C/I_F)$  is the ratio of the detector collector current to the LED input current with V<sub>CE</sub> at 10 volts.

2. The frequency at which  $i_{c}\mbox{ is 3 dB}$  down from the 1 kHz value.

3. Rise time  $(t_r)$  is the time required for the collector current to increase from 10% of its final value, to 90%. Fall time  $(t_f)$  is the time required for the collector current to decrease from 90% of its initial value to 10%.



# MCT4

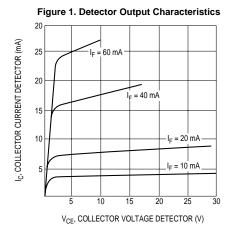
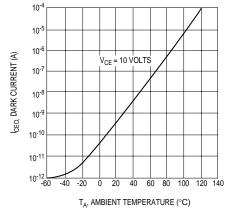


Figure 3. Dark Current vs. Temperature



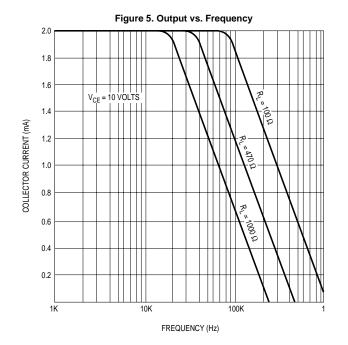
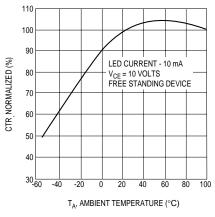
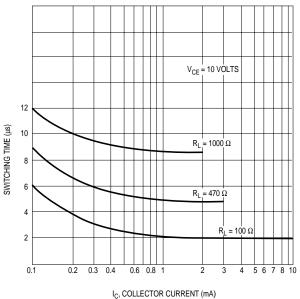


Figure 4. Current Output vs. Temperature

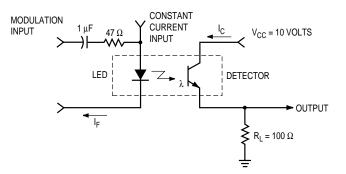


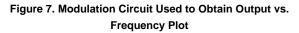






# MCT4





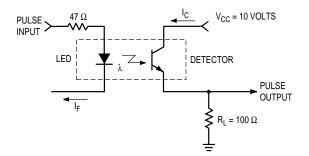


Figure 8. Circuit Used to Obtain Switching Time vs. Collector Current Plot



### MCT4

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